

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Toshihiko KARIYA</td> <td>10/22/2010</td> </tr> <tr> <td>Satoshi MIYAGAWA</td> <td>10/22/2010</td> </tr> <tr> <td>Naoki TODA</td> <td>10/22/2010</td> </tr> <tr> <td>Gen HAMADA</td> <td>10/22/2010</td> </tr> <tr> <td>Michitaka HATTORI</td> <td>10/22/2010</td> </tr> </tbody> </table>		Name	Execution Date	Toshihiko KARIYA	10/22/2010	Satoshi MIYAGAWA	10/22/2010	Naoki TODA	10/22/2010	Gen HAMADA	10/22/2010	Michitaka HATTORI	10/22/2010
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RECEIVING PARTY DATA													
<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;">Name:</td> <td>MITSUBISHI HEAVY INDUSTRIES PLASTIC TECHNOLOGY CO., LTD.</td> </tr> <tr> <td>Street Address:</td> <td>1, Aza Takamichi, Iwatsuka-cho,</td> </tr> <tr> <td>Internal Address:</td> <td>Nakamura-ku,</td> </tr> <tr> <td>City:</td> <td>Nagoya-shi, Aichi</td> </tr> <tr> <td>State/Country:</td> <td>JAPAN</td> </tr> <tr> <td>Postal Code:</td> <td>453-8515</td> </tr> </table>		Name:	MITSUBISHI HEAVY INDUSTRIES PLASTIC TECHNOLOGY CO., LTD.	Street Address:	1, Aza Takamichi, Iwatsuka-cho,	Internal Address:	Nakamura-ku,	City:	Nagoya-shi, Aichi	State/Country:	JAPAN	Postal Code:	453-8515
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CORRESPONDENCE DATA													
<p>Fax Number: (202)822-1111</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 2028221100</p> <p>Email: PatentMail@Whdapatentlaw.com</p> <p>Correspondent Name: Westerman, Hattori, Daniels & Adrian LLP</p> <p>Address Line 1: 1250 Connecticut Avenue NW,</p> <p>Address Line 2: Suite 700</p> <p>Address Line 4: Washington,, DISTRICT OF COLUMBIA 20036</p>													
ATTORNEY DOCKET NUMBER:	101349												

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PATENT
REEL: 025330 FRAME: 0121

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NAME OF SUBMITTER:

Sadao Kinashi

Total Attachments: 1

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U.S. ASSIGNMENT(Insert ASSIGNEE's
Name(s) Address(es))

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter ASSIGNOR) by

Mitsubishi Heavy Industries Plastic Technology Co., Ltd.**of 1, Aza Takamichi, Iwatsuka-cho, Nakamura-ku, Nagoya-shi, Aichi 453-8515 Japan**

(hereinafter ASSIGNEE), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled

(Title of Invention)

INJECTION MOLDING MACHINE AND INJECTION MOLDING METHOD

(*If the assignment is
being filed after the
filing of the
application, this
section must be
completed)

for which application for Letters Patent of the United States was executed on even date herewith unless otherwise indicated below:

* filed on _____ Serial No. _____

(Westerman, Hattori, Daniels & Adrian, LLP is hereby authorized to insert the series code, serial number and/or filing date hereon, when known)

and all Letters Patent of the United States to be obtained therefore on said application or any continuation, divisional, substitute, reissue or reexamination thereof for the full term or terms for which the same may be granted.

The ASSIGNOR agrees to execute all papers necessary in connection with the application and any continuation, divisional, reissue or reexamination applications thereof and also to execute separate assignments in connection with such applications as the ASSIGNEE may deem necessary or expedient.

The ASSIGNOR agrees to execute all papers necessary in connection with any interference, litigation, or other legal proceeding which may be declared concerning this application or any continuation, divisional, reissue or reexamination thereof or Letters Patent or reissue patent issued thereon and to cooperate with the ASSIGNEE in every way possible in obtaining and producing evidence and proceeding with such interference, litigation, or other legal proceeding.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

(Signatures)

Toshihiko Kariya
(Signature)Toshihiko KARIYA
(Type Name)October 22, 2010
(Date)Satoshi Miyagawa
(Signature)Satoshi MIYAGAWA
(Type Name)October 22, 2010
(Date)Naoki Toda
(Signature)Naoki TODA
(Type Name)October 22, 2010
(Date)Gen Hamada
(Signature)Gen HAMADA
(Type Name)October 22, 2010
(Date)Michitaka Hattori
(Signature)Michitaka HATTORI
(Type Name)October 22, 2010
(Date)

(Signature)

(Type Name)

(Date)

NO LEGALIZATION REQUIRED